

Certificate US12/82630
The management system of

SGS

Analog Technologies Corp.

11481 Rupp Drive, Burnsville, MN, 55337, United States Of America

has been assessed and certified as meeting the requirements of

AS 9100 D / ISO 9001:2015

SGS performed this assessment in accordance with the requirement of AS9104/1:Rev 2012 and is accredited under the Aerospace Registrar Management Program and ICOP Scheme.

For the following activities

Manufacturing process development, manufacturing, assembly, inspection, and testing of printed circuit board assemblies (PCBAs), cable assemblies, and electro-mechanical chassis. Services include quick-turn prototyping through full turnkey production. Special process capabilities include flip chip, wire bonding, Ball Grid Array (BGA) assembly, mixed metallurgy for BGAs, lead-free soldering, encapsulation, electronic component refinishing, and depanelization of printed circuit assemblies.

Certification Structure: Single site

This certificate is valid from / issue date 10 December 2024 until / expiry date 11 December 2027 and remains valid subject to satisfactory surveillance audits.

Re-Issue Date 30 October 2025

Issue 10. Certified since 11 December 2012



Authorised by

Viq Mohammed

Director - Technical Accreditation

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